



<u>Rev</u>	<u>Revise page</u>	<u>Revise contents</u>	<u>Date</u>	<u>Ref.No.</u>	<u>Reviser</u>
A1	N/A	Initial released	24-Jan-11	N/A	Yachuan Miao

## ■ ELECTRICAL SPECIFICATIONS

### Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature :  $25\pm 5^{\circ}\text{C}$   
 Relative humidity : 40%~70%

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature :  $25\pm 3^{\circ}\text{C}$   
 Relative humidity : 40%~70%

### Measure equipment

Electrical characteristics measured by MD 37WX-05M or equivalent.

### Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

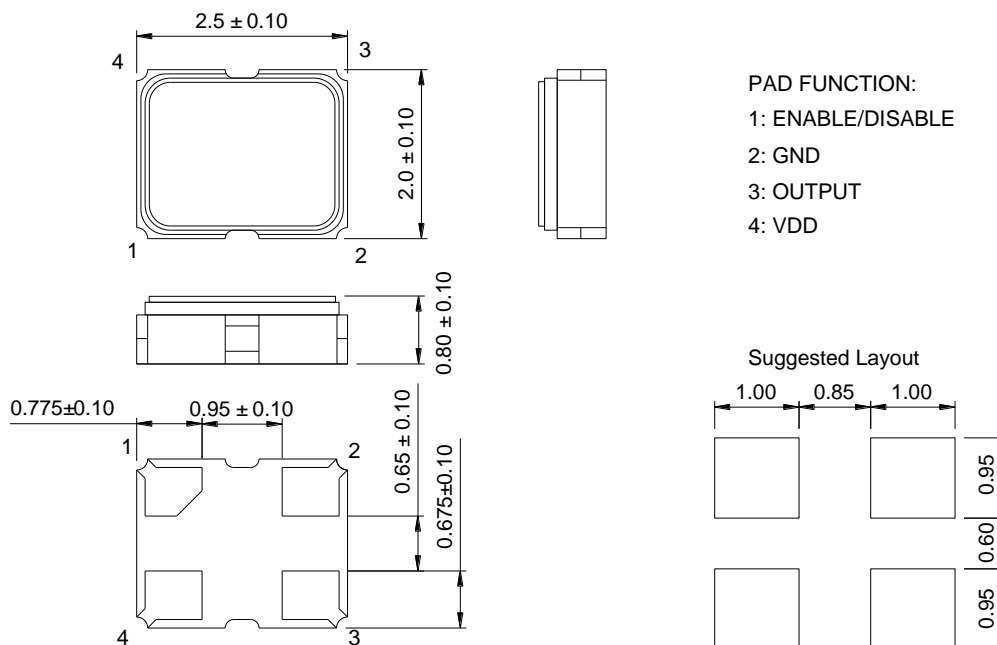
### Unit Weight:

0.015±0.002 g/pcs

	Parameters	Symbol	Electrical Spec.				Notes
			Min.	Typ.	Max.	Units	
1	Nominal Frequency	-	12.000000			MHz	-
2	Frequency Stability	-	±50			ppm	-
3	Operating Temperature	Topr	-10	25	70	°C	-
4	Storage Temperature	Tstg	-55	~	125	°C	-
5	Supply Voltage	VDD	3.30 ±10%			V	-
6	Input Current	Icc	-	-	10	mA	-
7	Enable Control	-	Yes			-	Pad 1
8	Output Load : CMOS	CL	15			pF	-
9	Output Voltage High	VoH	90%Vdd	-	-	V	-
10	Output Voltage Low	VoL	-	-	10%Vdd	V	-
11	Rise Time	Tr	-	-	10	ns	10%→90%VDD Level
12	Fall Time	Tf	-	-	10	ns	90%→10%VDD Level
13	Symmetry (Duty ratio)	TH/T	45	~	55	%	-
14	Start-up Time	Tosc	-	-	10	ms	-
15	Enable Voltage High	Vhi	70%Vdd	-	-	V	-
16	Disable Voltage Low	Vlo	-	-	30%Vdd	V	-
17	Aging	-	±3			ppm/yr.	1st. Year at 25°C
18	Output Disable Delay Time	T off	-	-	150	us	-
19	Output Enable Delay Time	T on	-	-	150	us	-

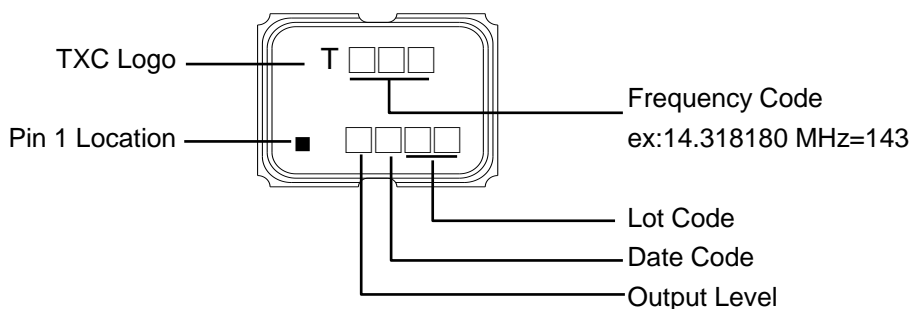
**■ DIMENSIONS**

(Unit:mm)



PAD FUNCTION:  
 1: ENABLE/DISABLE  
 2: GND  
 3: OUTPUT  
 4: VDD

**■ MARKING**



Output Level:

VDD(V)	5	3.3	2.8	2.5	1.8	2.9	3.0	2.85	2.6	2.55	2	1.5	2.7	3.4
CODE	A	B	C	D	E	F	G	H	J	K	L	M	N	P

Date Code:

YEAR				MONTH											
				JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2005	2009	2013	2017	A	B	C	D	E	F	G	H	J	K	L	M
2006	2010	2014	2018	N	P	Q	R	S	T	U	V	W	X	Y	Z
2007	2011	2015	2019	a	b	c	d	e	f	g	h	j	k	l	m
2008	2012	2016	2020	n	p	q	r	s	t	u	v	w	x	y	z

\*This date code will be cycled every four years

**Production location: Taiwan**

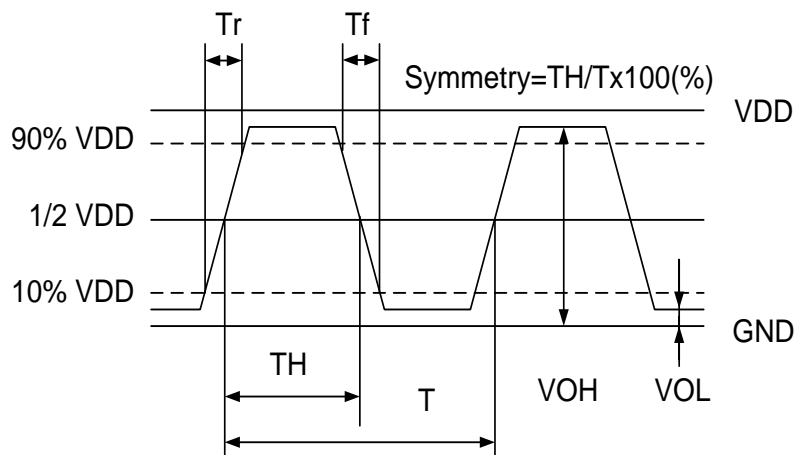
## ■ TEST DIAGRAM

Pad 1 : Tri-State control

Pad 1(OE)	Pad 3 (Output)	Oscillator
High (or open)	OSC out	Normal operation
Low	High impedance	Stop oscillation

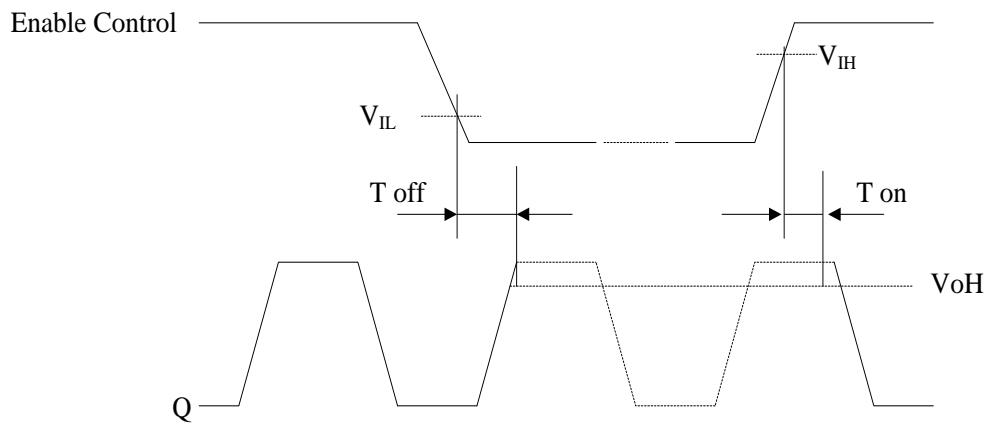
## ■ WAVEFORM CONDITIONS

Waveform measurement system should have a min. bandwidth of 5 times the frequency being tested.



### ■ OUTPUT ENABLE / DISABLE DELAY

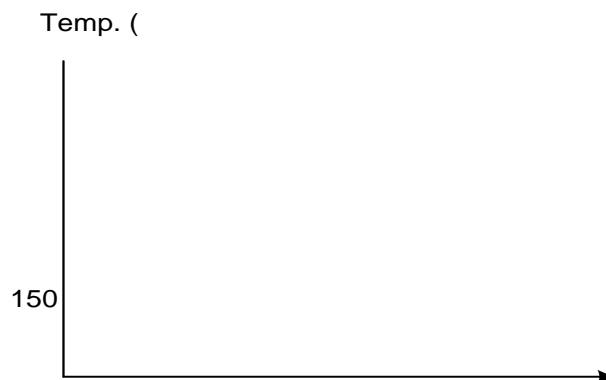
The following figure shows the oscillator timing during normal operation . Note that when the device is in standby, the oscillator stops. When standby is released, the oscillator starts and stable oscillator output occurs after a short delay.

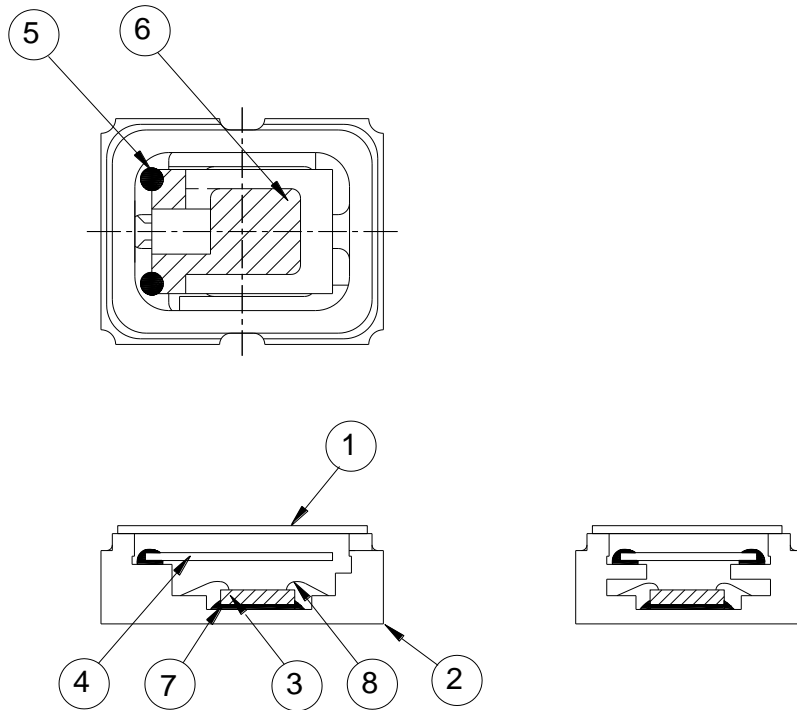


### ■ SUGGESTED REFLOW PROFILE

Total time : 200 sec. Max.

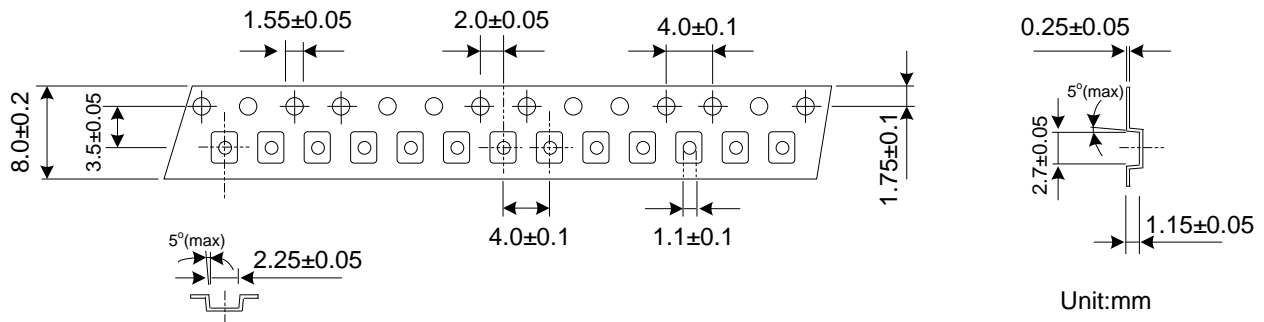
Solder melting point :220 °C



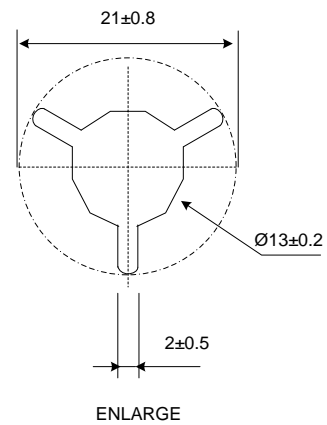
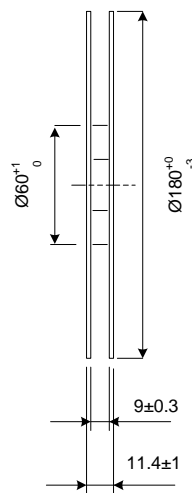
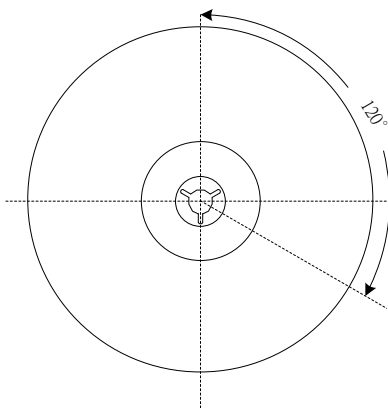
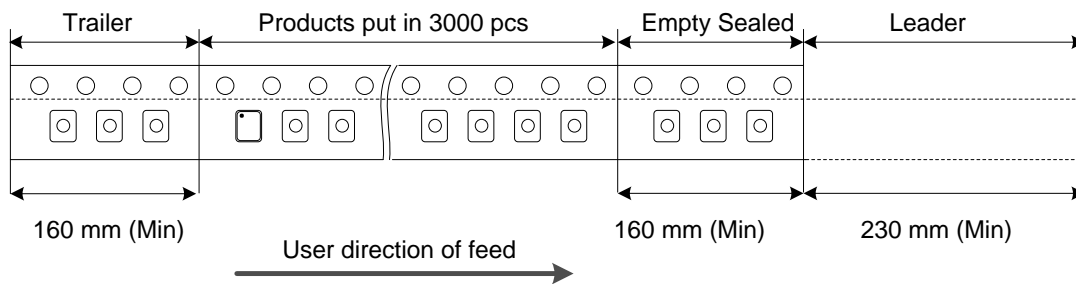
**■ STRUCTURE ILLUSTRATION**


NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Lid	Kovar (Fe/Co/Ni)	-
2	Base (Package)	Ceramic (Al <sub>2</sub> O <sub>3</sub> ) + Kovar (Fe/Co/Ni)+ Ag/Cu	-
3	IC chip	-	-
4	Crystal blank	SiO <sub>2</sub>	-
5	Conductive adhesive	Ag	Silicon resin
6	Electrode	Noble Metal	-
7	Die attached	Conductive (Ag)	Epoxy resin
8	Bonding wire	Au	Pad 1 options : NC is 5 wires , EN is 6 wires.

■ PACKING



REMARK :



## ■ RELIABILITY SPECIFICATIONS

### 1. Mechanical Endurance

No.	Test Item	Test Methods	REF. DOC
1	Drop Test	75 cm height, 3 times on concrete floor .	JIS C6701
1	Mechanical Shock	Device are shocked to half sine wave ( 1000 G ) three mutually perpendicular axes each 3 times. 0.5m sec. duration time	MIL-STD-202
1	Vibration	Frequency range                      10 ~ 2000 Hz Amplitude                                      1.52 mm/20G Sweep time                                      20 minute perpendicular axes each test time      4 Hrs (Total test time 12 Hrs)	MIL-STD-883
1	Gross Leak	Standard Sample For Automatic Gross Leak Detector, Test Pressure: 2kg / cm <sup>2</sup>	MIL-STD-883
2	Fine Leak	Helium Bombing 4.5 Kgf / cm <sup>2</sup> for 2 Hrs	
2	Solderability	Temperature                                      245 °C ± 5°C Immersing depth                                  0.5 mm minimum Immersion time                                      5 ± 1 seconds Flux    Rosin resin methyl alcohol solvent ( 1 : 4 )	MIL-STD-883

### 2. Environmental Endurance

No.	Test Item	Test Methods	REF. DOC
2	Resistance To Soldering Heat	Pre-heat temperature                      125 °C Pre-heat time                                      60 ~ 120 sec. Test temperature                                      260 ± 5 °C Test time    10 ± 1 sec.	MIL-STD-202
2	High Temp. Storage	+ 125 °C ± 3 °C for 1000 ± 12 Hrs	MIL-STD-883
2	Low Temp. Storage	- 40 °C ± 3 °C for 1000 ± 12 Hrs	
2	Thermal Shock	Total 100 cycles of the following temperature cycle 	MIL-STD-883
3	High Temp & Humidity	85°C ± 3°C, RH 85% , 1000 Hrs	JIS C5023
3	Pressure Cooker Storage	121 ± 3°C , RH100% , 2 bar , 240Hrs	JIS C6701